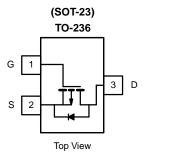


## G2303-VB Datasheet

# P-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) Typ.	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)	
	0.046 at V <sub>GS</sub> = - 10 V	- 5.6		
- 30	0.049 at V <sub>GS</sub> = - 6 V	- 5	11.4 nC	
	0.054 at V <sub>GS</sub> = - 4.5 V	-4.5		





#### **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested



#### **APPLICATIONS**

- For Mobile Computing
  - Load Switch
  - Notebook Adaptor Switch
  - DC/DC Converter

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	- 30	N/	
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
	T <sub>C</sub> = 25 °C		- 5.6		
Continuous Drain Current (T. 150 °C)	T <sub>C</sub> = 70 °C		- 5.1		
Continuous Drain Current ( $T_J = 150 \ ^{\circ}C$ )	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 5.4 <sup>b,c</sup>		
	T <sub>A</sub> = 70 °C		- 4.3 <sup>b,c</sup>	А	
Pulsed Drain Current (t = 100 µs)		I <sub>DM</sub>	- 18		
Continous Source-Drain Diode Current	T <sub>C</sub> = 25 °C		- 2.1		
	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 1 <sup>b,c</sup>		
	T <sub>C</sub> = 25 °C		2.5		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C		1.6	14/	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	1.25 <sup>b,c</sup>	W	
	T <sub>A</sub> = 70 °C	1	0.8 <sup>b,c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

#### THERMAL RESISTANCE RATINGS Parameter Symbol Typical Maximum Maximum Junction-to-Ambient<sup>b,d</sup> $t \le 5 s$ $\mathsf{R}_{\mathsf{thJA}}$ 75 100 40 Maximum Junction-to-Foot (Drain) 50 Steady State $\mathsf{R}_{\mathsf{thJF}}$

Notes:

a. Based on T<sub>C</sub> = 25 °C.
b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 166 °C/W.

Unit

°C/W

$\begin{array}{ c c c c c c c c c c c c c c c c c c c$						www.VE	Bsemi.co
$\begin{array}{ c c c c c c } \hline Parameter & Symbol & Test Conditions & Min. & Typ. & Max. & Unit \\ \hline Static & & & & & & & & & & & & & & & & & & &$							
$\begin{array}{ c c c c c c } \hline Parameter & Symbol & Test Conditions & Min. & Typ. & Max. & Unit \\ \hline Static & & & & & & & & & & & & & & & & & & &$	SPECIFICATIONS (T = 25 °C	unloss otho	nvice poted)				
	· · · · · · · · · · · · · · · · · · ·			Min	Typ	Max	Unit
$\begin{array}{c c c c c c c c c c c c c c c c c c c $		Symbol	Test conditions		iyp.		Unit
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $		Vns	V <sub>GS</sub> = 0 V, I <sub>D</sub> = - 250 µA	- 30			V
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$					- 19		-
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $			I <sub>D</sub> = - 250 μA		-		mV/°C
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	( · )	. ,	Vps = Vcs . lp = - 250 µA	- 0.5	•	- 2.0	V
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $							-
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $		000					
$ \begin{array}{ c c c c c } & V_{GS} - 10 \ V, \ I_{D} = \cdot 4.4 \ A & 0.046 \\ \hline V_{GS} - 6 \ V, \ I_{D} = \cdot 4 \ A & 0.046 \\ \hline V_{GS} - 6 \ V, \ I_{D} = \cdot 4 \ A & 0.049 \\ \hline V_{GS} - 6 \ V, \ I_{D} = \cdot 4 \ A & 0.049 \\ \hline V_{GS} - 6 \ V, \ I_{D} = \cdot 3.4 \ A & 0.054 \\ \hline V_{GS} - 4.5 \ V, \ I_{D} = \cdot 3.4 \ A & 0.054 \\ \hline V_{GS} - 4.5 \ V, \ I_{D} = \cdot 3.4 \ A & 0.054 \\ \hline V_{DS} = \cdot 15 \ V, \ I_{D} = \cdot 3.4 \ A & 0.054 \\ \hline V_{DS} = -15 \ V, \ I_{D} = \cdot 3.4 \ A & 0.054 \\ \hline V_{DS} = -15 \ V, \ V_{DS} = 0 \ V, \ I_{D} = \cdot 3.4 \ A & 0.054 \\ \hline V_{DS} = -15 \ V, \ V_{DS} = 0 \ V, \ I_{D} = \cdot 3.4 \ A & 0.054 \\ \hline V_{DS} = -15 \ V, \ V_{SS} = 0 \ V, \ I_{D} = \cdot 5.4 \ A & 0.054 \\ \hline V_{DS} = -15 \ V, \ V_{SS} = 0 \ V, \ I_{D} = \cdot 5.4 \ A & 0.054 \\ \hline V_{DS} = -15 \ V, \ V_{SS} = 0 \ V, \ I_{D} = \cdot 5.4 \ A & 0.054 \\ \hline V_{DS} = -15 \ V, \ V_{SS} = 0 \ V, \ I_{D} = \cdot 5.4 \ A & 0.054 \\ \hline V_{DS} = -15 \ V, \ V_{SS} = 0 \ V, \ I_{D} = \cdot 5.4 \ A & 0.054 \\ \hline V_{DS} = -15 \ V, \ V_{SS} = -10 \ V, \ I_{D} = \cdot 5.4 \ A & 0.054 \\ \hline V_{DS} = -15 \ V, \ V_{SS} = 0 \ V, \ I_{D} = \cdot 5.4 \ A & 0.054 \\ \hline V_{DS} = -15 \ V, \ V_{SS} = -10 \ V, \ I_{D} = \cdot 5.4 \ A & 0.054 \\ \hline V_{DS} = -15 \ V, \ V_{SS} = -10 \ V, \ I_{D} = \cdot 5.4 \ A & 0.054 \\ \hline V_{DS} = -15 \ V, \ V_{SS} = -10 \ V, \ I_{D} = -5.4 \ A & 0.054 \\ \hline V_{DS} = -15 \ V, \ V_{CS} = -10 \ V, \ I_{D} = -5.4 \ A & 0.054 \\ \hline V_{DD} = -15 \ V, \ V_{CS} = -10 \ V, \ I_{S} = 1.0 \\ \hline I_{D} = -4.3 \ A, \ V_{GEN} = -10 \ V, \ R_{g} = 1.0 \\ \hline I_{D} = -4.3 \ A, \ V_{GEN} = -4.5 \ V, \ R_{g} = 1.0 \\ \hline I_{D} = -4.3 \ A, \ V_{CS} = -4.5 \ V, \ R_{g} = 1.0 \\ \hline I_{D} = -2.1 \ V \ V_{DS} = -15 \ V, \ V_{CS} = -4.5 \ V, \ V_{S} = -10 \ V \ V_{S} \\ \hline V_{DD} = -15 \ V, \ R_{g} = 1.0 \\ \hline I_{D} = -15 \ V, \ R_{g} = 1.0 \\ \hline I_{D} = -15 \ V, \ R_{g} = 1.0 \\ \hline I_{D} = -15 \ V, \ R_{g} = 1.0 \\ \hline I_{D} = -15 \ V, \ R_{g} = 1.0 \\ \hline I_{D} = -15 \ V, \ R_{g} = 1.0 \\ \hline I_{D} = -15 \ V, \ R_{g} = 1.0 \\ \hline I_{D} = -15 \ V, \ R_{g} = 1.0 \\ \hline I_{D} = -15 \ V, \ R_{g} = 1.0 \\ \hline I_{D} = -15 \ V, \ R_{g} = 0 \ V \ I_{D} = -15 \ V, \ R_{g} = 1.0 $	Zero Gate Voltage Drain Current	I <sub>DSS</sub>					μA
$ \begin{array}{ c c c c c c } \hline \mbox{Markev} & Ma$	On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le$ - 5 V, $V_{GS}$ = - 10 V	- 2.5			Α
$ \begin{array}{ c c c c c c c } \hline V_{GS} = -4.5 \ V, \ I_D = -3.6 \ A & 0.054 \\ \hline \hline V_{CS} = -15 \ V, \ I_D = -3.4 \ A & 18 \\ \hline \hline S \\ \hline \hline Pynamic^b \\ \hline \hline \\ \hline Pynamic^b \\ \hline \\ \hline \\ \hline Pynamic^b \\ \hline \\ $		. ,	V <sub>GS</sub> =- 10 V, I <sub>D</sub> = - 4.4 A		0.046		
$ \begin{array}{ c c c c c c } \hline V_{GS} = \cdot 4.5 \ V, \ I_{D} = \cdot 3.6 \ A & 0.054 & \\ \hline V_{DS} = \cdot 15 \ V, \ I_{D} = \cdot 3.4 \ A & 18 & \\ \hline S \\ \hline Dynamic^b \\ \hline \\ \hline Dynamic^b \\ \hline \\ \hline Duput Capacitance & C_{ISS} & \\ \hline Output Capacitance & C_{GSS} & \\ \hline \\ Output Capacitance & C_{GSS} & \\ \hline \\ Peresers Transfer Capacitance & C_{GS} & \\ \hline \\ Total Gate Charge & Q_g & \\ \hline \\ Gate-Source Charge & Q_{gs} & \\ \hline \\ Gate-Source Charge & Q_{gg} & \\ \hline \\ \\ Gate-Source Charge & Q_{gg} & \\ \hline \\ \\ Gate-Source Charge & Q_{gg} & \\ \hline \\ \hline \\ \\ Gate-Source Charge & Q_{gg} & \\ \hline \\ \\ \hline \\ Gate-Source Charge & Q_{gg} & \\ \hline \\ \\ \hline \\ Gate-Source Charge & Q_{gg} & \\ \hline \\ \\ \hline \\ \\ Gate-Source Charge & Q_{gg} & \\ \hline \\ \\ \hline \\ \\ \\ \hline \\ \\ \\ \hline \\ \\ \\ \hline \\ \\ \hline \\ \\ \hline \\ \\ \hline \\ \\ \hline \\ \\ \\ \hline \\ \\ \\ \hline \\ \\ \hline \\ \\ \hline \\ \\ \hline \\$	Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> =- 6 V, I <sub>D</sub> = - 4 A		0.049		Ω
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $			V <sub>GS</sub> =- 4.5 V, I <sub>D</sub> = - 3.6 A		0.054		
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 3.4 A		18		S
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Dynamic <sup>b</sup>				Į	<u>.                                    </u>	<u>.                                    </u>
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Input Capacitance	C <sub>iss</sub>			1295		
$ \begin{array}{ c c c c c c } \hline Reverse Transfer Capacitance & C_{rss} & & & & & 130 & & & \\ \hline Total Gate Charge & O_{g} & & V_{DS} = -15 V, V_{GS} = -10 V, I_{D} = -5.4 A & & 24 & 36 & & & \\ \hline Total Gate Charge & O_{gs} & & & & & & 11.4 & 17 & & \\ \hline Gate-Source Charge & O_{gd} & & & & & & & & & & & & & \\ \hline Gate Resistance & R_{g} & f = 1 MHz & & 1.5 & 7.7 & 15.4 & & & & \\ \hline Gate Resistance & R_{g} & f = 1 MHz & & 1.5 & 7.7 & 15.4 & & & & & \\ \hline Turn-On Delay Time & I_{d(on)} & & & & & & & & & & & \\ \hline Turn-Off Delay Time & I_{d(off)} & & & & & & & & & & & & & \\ \hline Fall Time & I_{t} & & & & & & & & & & & & & \\ \hline Turn-On Delay Time & I_{d(off)} & & & & & & & & & & & & & & \\ \hline Rise Time & I_{t} & & & & & & & & & & & & & & & & & \\ \hline Turn-Off Delay Time & I_{d(off)} & & & & & & & & & & & & & & & & & \\ \hline Fall Time & I_{t} & & & & & & & & & & & & & & & & & & \\ \hline Turn-Off Delay Time & I_{d(off)} & & & & & & & & & & & & & & & & & \\ \hline Turn-Off Delay Time & I_{t} & & & & & & & & & & & & & & & & & & &$	Output Capacitance		V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		150		pF
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Reverse Transfer Capacitance				130		
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$		,	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 5.4 A	4 A 24		36	<u> </u>
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Iotal Gate Charge				11.4	17	
$ \begin{array}{ c c c c } \hline Gate-Drain Charge & Q_{gd} & & & & & & & & & & & & & & & & & & &$	Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = - 15 V, $V_{GS}$ = - 4.5 V, $I_{D}$ = - 5.4 A		3.4		nC
$ \begin{array}{c c c c c c c c } \hline Turn-On Delay Time & t_{d(on)} & & & & & & & & & & & & & & & & & & &$	Gate-Drain Charge				3.8		
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Gate Resistance	R <sub>g</sub>	f = 1 MHz	1.5	7.7	15.4	Ω
$\begin{tabular}{ c c c c c c } \hline Turn-Off Delay Time & t_d(off) & I_D \cong -4.3 \ A, \ V_{GEN} = -10 \ V, \ R_g = 1 \ \Omega & 38 & 57 & 6 & 12 & 6 & 12 & 6 & 12 & 6 & 12 & 6 & 12 & 7 & 7 & 14 & nC & 0 & 0 & 0 & 0 & 0 & 0 & 0 & 0 & 0 & $	Turn-On Delay Time	t <sub>d(on)</sub>			13	20	
$\begin{array}{c c c c c c c } \hline Fall Time & It_{f} & Ic & I$	Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_L$ = 3.5 $\Omega$		4	8	
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong$ - 4.3 A, $\text{V}_\text{GEN}$ = - 10 V, $\text{R}_\text{g}$ = 1 $\Omega$		38	57	
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Fall Time	t <sub>f</sub>	1		6	12	
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Turn-On Delay Time	t <sub>d(on)</sub>			28	42	ns
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, R <sub>L</sub> = 3.5 $\Omega$		16	24	
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ - 4.3 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$		30	45	
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Fall Time		1		10	20	
Pulse Diode Forward Current (t = 100 µs)ISM- 80ABody Diode Voltage $V_{SD}$ $I_S = -4.3 \text{ A}, V_{GS} = 0 \text{ V}$ - 0.8- 1.2VBody Diode Reverse Recovery Time $t_{rr}$ 1523nsBody Diode Reverse Recovery Charge $Q_{rr}$ $I_F = -4.3 \text{ A}, dI/dt = 100 \text{ A/µs}, T_J = 25 °C$ 714nCReverse Recovery Fall Time $t_a$ ncnsnsns	Drain-Source Body Diode Characteristic	s					
Pulse Diode Forward Current (t = 100 µs) $I_{SM}$ 80Body Diode Voltage $V_{SD}$ $I_S = -4.3 \text{ A}, V_{GS} = 0 \text{ V}$ -0.8-1.2VBody Diode Reverse Recovery Time $t_{rr}$ 1523nsBody Diode Reverse Recovery Charge $Q_{rr}$ $I_F = -4.3 \text{ A}, dl/dt = 100 \text{ A/µs}, T_J = 25 °C$ 714nCReverse Recovery Fall Time $t_a$ nsnsns	Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			- 2.1	Δ
Body Diode Reverse Recovery Time $t_{rr}$ 1523nsBody Diode Reverse Recovery Charge $Q_{rr}$ Reverse Recovery Fall Time $t_a$	Pulse Diode Forward Current (t = $100  \mu s$ )	I <sub>SM</sub>				- 80	~
Body Diode Reverse Recovery Charge $Q_{rr}$ Reverse Recovery Fall Time $t_a$ IF = - 4.3 A, dl/dt = 100 A/µs, T_J = 25 °C       7       14       nC	Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 4.3 A, V <sub>GS</sub> = 0 V		- 0.8	- 1.2	V
Reverse Recovery Fall Time $t_a$ $I_F = -4.3 \text{ A}, dl/dt = 100 \text{ A/µs}, I_J = 25 \text{ °C}$ 8	Body Diode Reverse Recovery Time	t <sub>rr</sub>			15	23	ns
Reverse Recovery Fall Time t <sub>a</sub> 8 ns	Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$I_{r} = -4.3 \text{ A} \text{ d}/\text{d}t = 100 \text{ A/us } T_{r} = 25 \text{ °C}$		7	14	nC
Reverse Recovery Rise Time t <sub>b</sub> 7	Reverse Recovery Fall Time	t <sub>a</sub>			8		- ns
	Reverse Recovery Rise Time	t <sub>b</sub>			7		

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

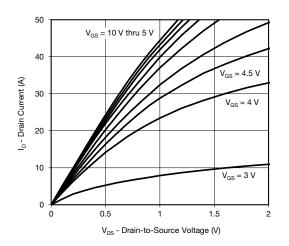
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

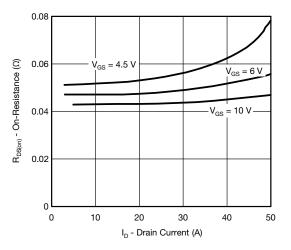
VB<u>semi</u>



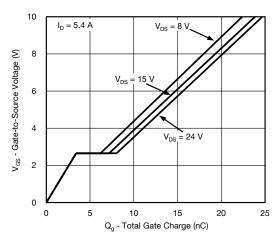




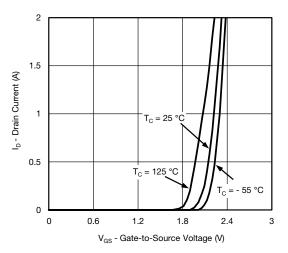
**Output Characteristics** 



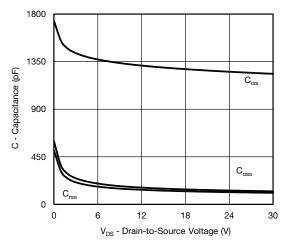
**On-Resistance vs. Drain Current** 



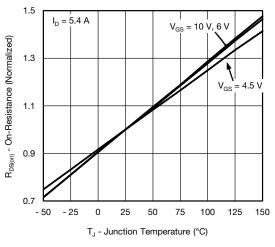
**Gate Charge** 



**Transfer Characteristics** 

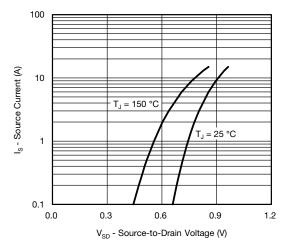


Capacitance



**On-Resistance vs. Junction Temperature** 



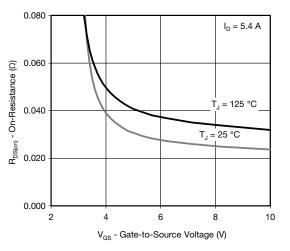


#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

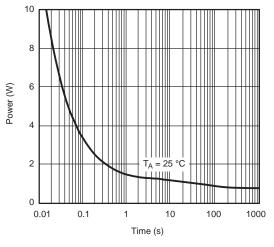




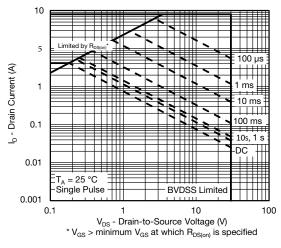
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



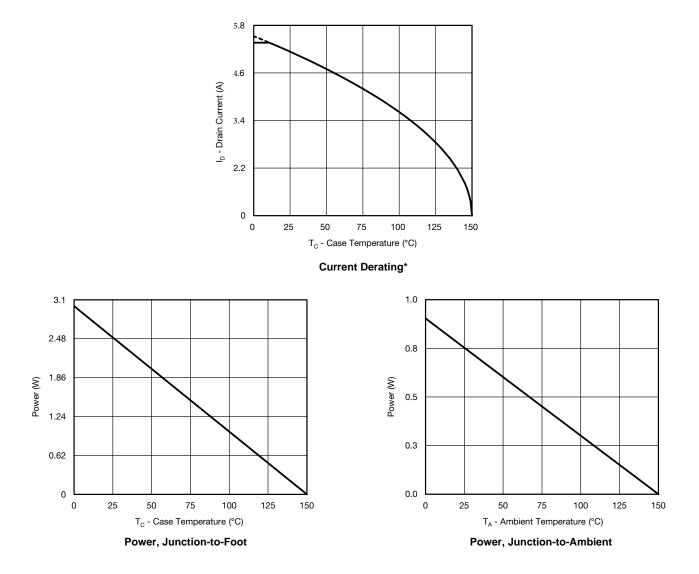
Single Pulse Power (Junction-to-Ambient)



Safe Operating Area, Junction-to-Ambient



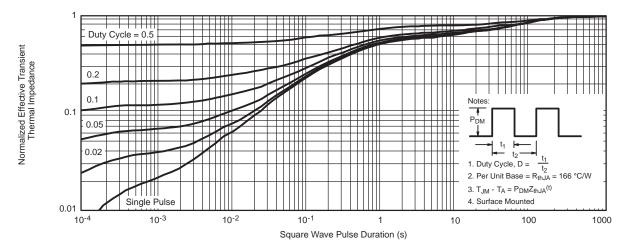
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



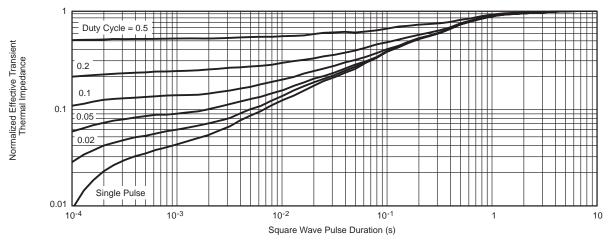
\* The power dissipation  $P_D$  is based on  $T_{J(max.)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



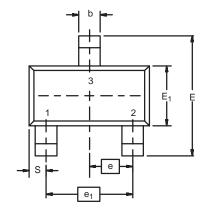
Normalized Thermal Transient Impedance, Junction-to-Ambient

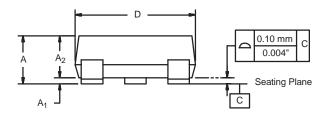


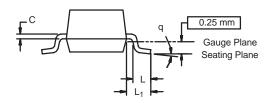
Normalized Thermal Transient Impedance, Junction-to-Foot



### SOT-23 (TO-236): 3-LEAD



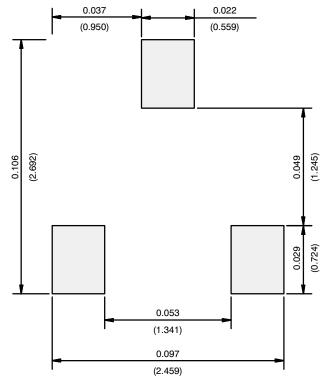




Dim	MILLIMETERS		INCHES		
	Min	Max	Min	Мах	
Α	0.89	1.12	0.035	0.044	
A <sub>1</sub>	0.01	0.10	0.0004	0.004	
A <sub>2</sub>	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E <sub>1</sub>	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e <sub>1</sub>	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L <sub>1</sub>	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	



#### **RECOMMENDED MINIMUM PADS FOR SOT-23**



Recommended Minimum Pads Dimensions in Inches/(mm)



# Disclaimer

All products due to improve reliability, function or design or for other reasons, product specifications and data are subject to change without notice.

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